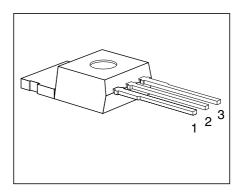


### **Features**

- N channel
- Logic level
- Enhancement mode
- Temperature sensor with thyristor characteristicThe drain pin is electrically shorted to the tab



Pin	1	2	3
	G	D	S

Туре	$V_{ t DS}$	$I_{ extsf{D}}$	$R_{DS(on)}$	Package	Ordering Code
BTS 115A	50 V	15.5 A	0.12 Ω	TO-220AB	C67078-S5004-A2

# **Maximum Ratings**

Parameter	Symbol	Values	Unit
Drain-source voltage	$V_{ t DS}$	50	٧
Drain-gate voltage, $R_{GS}$ = 20 kΩ	$V_{DGR}$	50	
Gate-source voltage	$V_{GS}$	± 10	
Continuous drain current, $T_{\rm C}$ = 25 °C	$I_{D}$	15.5	Α
ISO drain current $T_{\rm C}$ = 85 °C, $V_{\rm GS}$ = 4.5 V, $V_{\rm DS}$ = 0.5 V	$I_{ t D-ISO}$	3.2	
Pulsed drain current, $T_{\rm C} = 25  ^{\circ}{\rm C}$	$I_{D}$ puls	62	
Short circuit current, $T_j = -55 \dots + 150 ^{\circ}\text{C}$	$I_{ m SC}$	37	
Short circuit dissipation, $T_j = -55 \dots + 150 ^{\circ}\text{C}$	$P_{SCmax}$	550	W
Power dissipation	$P_{tot}$	50	
Operating and storage temperature range	$T_{\rm j}$ , $T_{\rm stg}$	- 55 + 150	°C
DIN humidity category, DIN 40 040	_	Е	_
IEC climatic category, DIN IEC 68-1	_	55/150/56	
Thermal resistance			K/W
Chip-case	$R_{thJC}$	≤ 2.5	
Chip-ambient Chip-ambient	$R_{thJA}$	≤ 75	

1 19.02.04



# **Electrical Characteristics**

at  $T_{\rm j}$  = 25 °C, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Static Characteristics					
Drain-source breakdown voltage $V_{\rm GS}$ = 0, $I_{\rm D}$ = 0.25 mA	$V_{(BR)DSS}$	50	_	_	V
Gate threshold voltage $V_{\rm GS} = V_{\rm DS}, I_{\rm D} = 1.0 \ {\rm mA}$	$V_{GS(th)}$	1.5	2.0	2.5	
Zero gate voltage drain current $V_{\rm GS}$ = 0 V, $V_{\rm DS}$ = 50 V $T_{\rm j}$ = 25 °C $T_{\rm i}$ = 125 °C	$I_{ extsf{DSS}}$	_	0.1	1.0	μΑ
Gate-source leakage current $V_{\rm GS}$ = 20 V, $V_{\rm DS}$ = 0 $T_{\rm j}$ = 25 °C $T_{\rm i}$ = 150 °C	$I_{ ext{GSS}}$		10	100	nA μA
Drain-source on-state resistance $V_{\rm GS}$ = 4.5 V, $I_{\rm D}$ = 7.8 A	$R_{DS(on)}$	_	0.09	0.12	Ω
Dynamic Characteristics					•
Forward transconductance $V_{\rm DS} \ge 2 \times I_{\rm D} \times R_{\rm DS(on)max}, I_{\rm D}$ =7.8 A	$g_{fs}$	5.5	9.5	_	S
Input capacitance $V_{\rm GS}$ = 0, $V_{\rm DS}$ = 25 V, $f$ = 1 MHz	$C_{iss}$	_	550	735	pF
Output capacitance $V_{\rm GS}$ = 0, $V_{\rm DS}$ = 25 V, $f$ = 1 MHz	$C_{ m oss}$	_	220	320	
Reverse transfer capacitance $V_{\rm GS}$ = 0, $V_{\rm DS}$ = 25 V, $f$ = 1 MHz	$C_{rss}$	_	85	150	
Turn-on time $t_{\rm on}$ , $(t_{\rm on}=t_{\rm d(on)}+t_{\rm r})$ $V_{\rm CC}=30$ V, $V_{\rm GS}=5$ V, $I_{\rm D}=3$ A, $R_{\rm GS}=50$ $\Omega$	$t_{d(on)}$		15 70	25 100	ns
Turn-off time $t_{\text{off}}$ , $(t_{\text{off}} = t_{\text{d(off)}} + t_{\text{f}})$	$t_{\rm r}$ $t_{\rm d(off)}$	_	70	90	
$V_{\rm CC}$ = 30 V, $V_{\rm GS}$ = 10 V, $I_{\rm D}$ = 3 A, $R_{\rm GS}$ = 50 $\Omega$	$t_{f}$	_	50	70	



# **Electrical Characteristics** (cont'd)

at  $T_{\rm j}$  = 25 °C, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Reverse Diode					
Continuous source current	Is	_	_	15.5	Α
Pulsed source current	$I_{SM}$	_	_	62	
Diode forward on-voltage $I_{\rm F}$ = 15.5 A, $V_{\rm GS}$ = 0 V	$V_{SD}$	_	1.3	1.6	V
Reverse recovery time $I_F = I_S$ , $di_F/dt = 100 \text{ A/}\mu\text{s}$ , $V_R = 30 \text{ V}$	t <sub>rr</sub>	_	60	_	ns
Reverse recovery charge $I_F = I_S$ , $di_F/dt = 100$ A/ $\mu$ s, $V_R = 30$ V	$Q_{rr}$	_	0.10	_	μС
Temperature Sensor			·		
Forward voltage $I_{TS(on)} = 5.0$ mA, $T_j = -55$ + 150 °C Sensor override, $t_p \le 100$ $\mu s$	$V_{TS(on)}$		1.3	1.4	V
$T_{\rm j} = -55 \dots + 160 {}^{\circ}{\rm C}$		_	_	10	
Forward current $T_{\rm j} = -55 \dots + 150 ^{\circ}{\rm C}$ Sensor override, $t_{\rm p} \le 100 \mu{\rm s}$	$I_{TS(on)}$	_	_	5	mA
<i>T</i> <sub>j</sub> = − 55 + 160 °C		_	_	600	
Holding current, $V_{\rm TS(off)}$ = 5 V, $T_{\rm j}$ = 25 °C $T_{\rm j}$ = 150 °C	$I_{H}$	0.05 0.05	0.1 0.2	0.5 0.3	
Switching temperature $V_{TS} = 5 \text{ V}$	$T_{TS(on)}$	150	_	_	°C
Turn-off time $V_{TS} = 5 \text{ V}, I_{TS(on)} = 2 \text{ mA}$	$t_{ m off}$	0.5	_	2.5	μs



## **Examples for short-circuit protection**

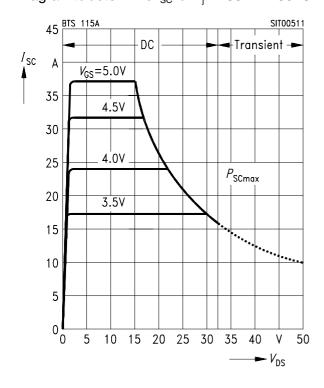
at  $T_{\rm j}$  = -55 ... + 150 °C, unless otherwise specified.

Parameter	Symbol	Examples			Unit
		1	2	_	
Drain-source voltage	$V_{ t DS}$	15	30	_	V
Gate-source voltage	$V_{GS}$	5.0	3.5	_	
Short-circuit current	$I_{ m SC}$	37	17	_	Α
Short-circuit dissipation	$P_{SC}$	550	510	_	W
Response time $T_i = 25 ^{\circ}\text{C}$ , before short circuit	$t_{ m SC(off)}$	25	25	_	ms

# Short-circuit protection $I_{SC} = f(V_{DS})$

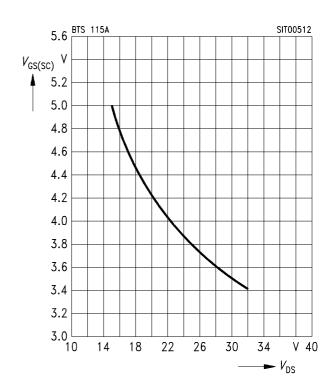
Parameter:  $V_{\rm GS}$ 

Diagram to determine  $I_{SC}$  for  $T_j = -55 \dots + 150 \,^{\circ}$ C



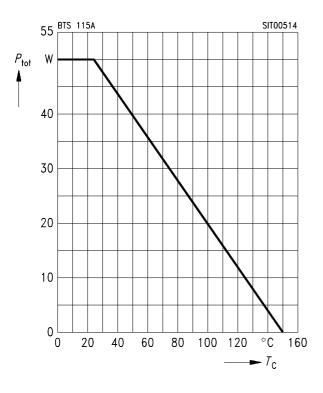
Max. gate voltage  $V_{\rm GS(SC)} = f(V_{\rm DS})$ 

Parameter:  $T_j = -55 \dots + 150 \,^{\circ}\text{C}$ 

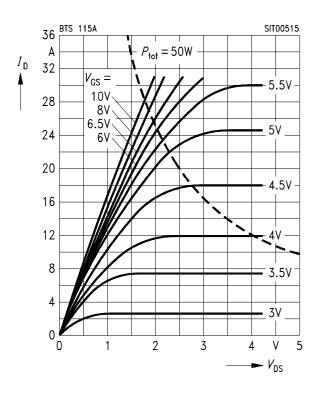




## Max. power dissipation $P_{\text{tot}} = f(T_{\text{C}})$

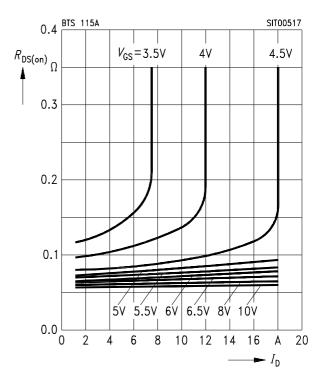


Typical output characteristics  $I_{\rm D}$  = f ( $V_{\rm DS}$ ) Parameter:  $t_{\rm p}$  = 80  $\mu {\rm s}$ 

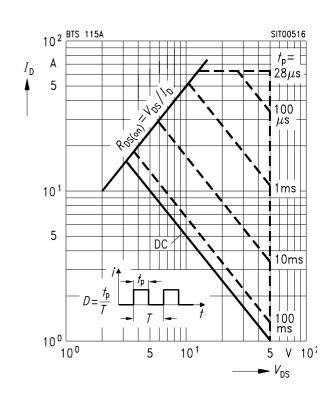


## Typ. drain-source on-state resistance

 $R_{\rm DS(on)} = f(I_{\rm D})$ Parameter:  $V_{\rm GS}$ 



Safe operating area  $I_D = f(V_{DS})$ Parameter: D = 0.01,  $T_C = 25$  °C

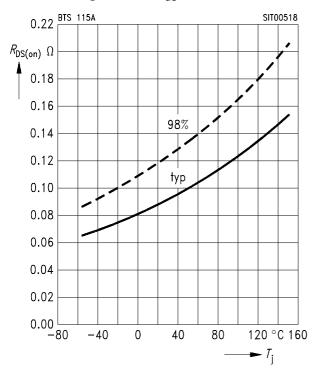




### **Drain-source on-state resistance**

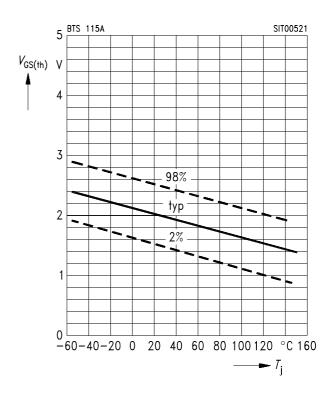
 $R_{\rm DS(on)} = f(T_{\rm i})$ 

Parameter:  $I_D = 7.8 \text{ A}, V_{GS} = 4.5 \text{ V}$ 



# Gate threshold voltage $V_{\mathrm{GS(th)}} = f\left(T_{\mathrm{j}}\right)$

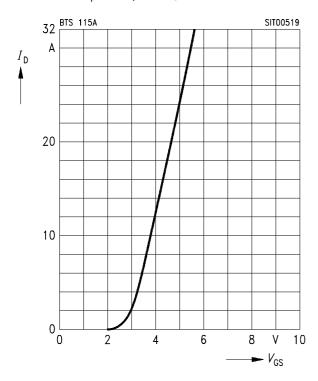
Parameter:  $V_{DS} = V_{GS}$ ,  $I_{D} = -1$  mA



## Typ. transfer characteristic

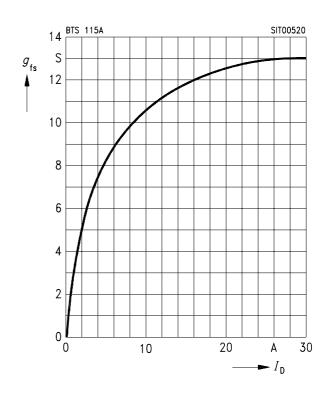
 $I_{\rm D} = f(V_{\rm GS})$ 

Parameter:  $t_p = 80 \mu s$ ,  $V_{DS} = -25 \text{ V}$ 



# Typ. transconductance $g_{fs} = f(I_D)$

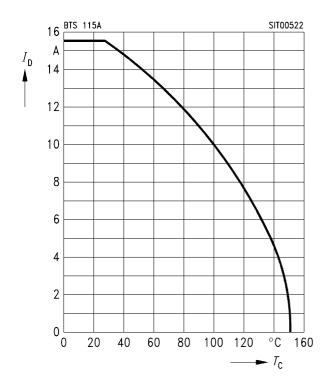
Parameter:  $t_p$  = 80  $\mu$ s,  $V_{DS}$  = -25 V





## Continuous drain current $I_D = f(T_C)$

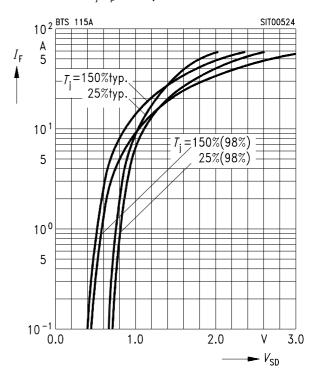
Parameter:  $V_{GS} \ge 4.5 \text{ V}$ 



### Forward characteristics of reverse diode

 $I_{\mathsf{F}} = f(V_{\mathsf{SD}})$ 

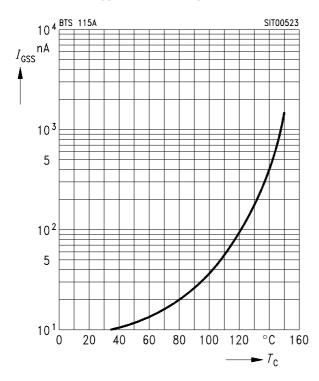
Parameter:  $T_{\rm j}$ ,  $t_{\rm p}$  = 80  $\mu$ s



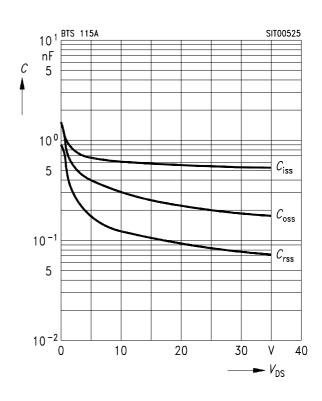
# Typ. gate-source leakage current

 $I_{\rm GSS} = f(T_{\rm C})$ 

Parameter:  $V_{GS} = -20 \text{ V}$ ,  $V_{DS} = 0$ 



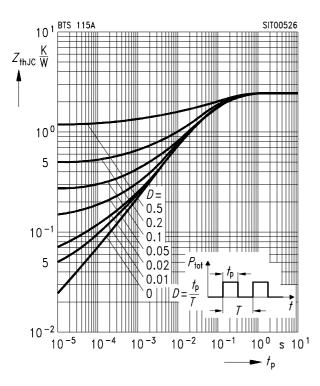
Typ. capacitances  $C = f(V_{DS})$ Parameter:  $V_{GS} = 0$ , f = 1 MHz





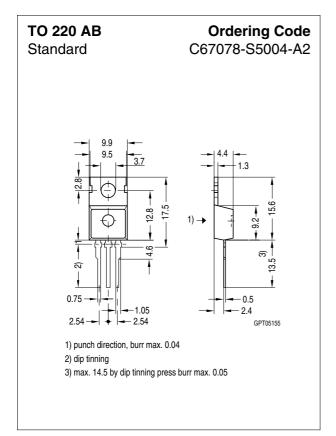
# Transient thermal impedance $Z_{\text{thJC}} = f(t_{\text{p}})$

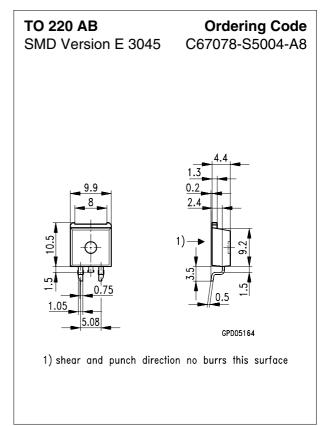
Parameter:  $D = t_p/T$ 











## TEMPFET® BTS 115 A



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